


THREE PHASE CONTROLLED BRIDGE

Power Modules

Features

- Package fully compatible with the industry standard INT-A-pak power modules series
- High thermal conductivity package, electrically insulated case
- Outstanding number of power encapsulated components
- Excellent power volume ratio
- 4000 V_{RMS} isolating voltage
- UL E78996 approved 

55 A
90 A
110 A

Description

A range of extremely compact, encapsulated three phase controlled bridge rectifiers offering efficient and reliable operation. They are intended for use in general purpose and heavy duty applications.

Major Ratings and Characteristics

Parameters	53MT.KB 52MT.KB 51MT.KB	93MT.KB 92MT.KB 91MT.KB	113MT.KB 112MT.KB 111MT.KB	Units
I_o	55	90	110	A
@ T_c	85	85	85	°C
I_{FSM}				
@ 50Hz	390	950	1130	A
@ 60Hz	410	1000	1180	A
I^2t				
@ 50Hz	770	4525	6380	A ² s
@ 60Hz	700	4130	5830	A ² s
$I^2\sqrt{t}$	7700	45250	63800	A ² √s
V_{RRM} range	800 to 1600			V
T_{STG} range	-40 to 125			°C
T_J range	-40 to 125			°C

53-93-113MT..KB Series

Bulletin I27503 08/97

International
 TOR Rectifier

ELECTRICAL SPECIFICATIONS

Voltage Ratings

Type number	Voltage Code	V_{RRM} , maximum repetitive peak reverse voltage V	V_{RSM} , maximum non-repetitive peak reverse voltage V	V_{DRM} , max. repetitive peak off-state voltage gate open circuit V	I_{RRM}/I_{DRM} max. @ $T_J = 125^\circ\text{C}$ mA
53/52/51MT..KB	80	800	900	800	10
	100	1000	1100	1000	
	120	1200	1300	1200	
	140	1400	1500	1400	
	160	1600	1700	1600	
93/92/91MT..KB 113/112/111MT..KB	80	800	900	800	20
	100	1000	1100	1000	
	120	1200	1300	1200	
	140	1400	1500	1400	
	160	1600	1700	1600	

Forward Conduction

Parameter	53MT..KB 52MT..KB 51MT..KB	93MT..KB 92MT..KB 91MT..KB	113MT..KB 112MT..KB 111MT..KB	Units	Conditions
I_O Maximum DC output current @ Case temperature	55	90	110	A	120° Rect conduction angle
	85	85	85	°C	
I_{TSM} Maximum peak, one-cycle forward, non-repetitive on state surge current	390	950	1130	A	t = 10ms No voltage reappplied
	410	1000	1180		t = 8.3ms
	330	800	950		t = 10ms 100% V_{RRM} reappplied
	345	840	1000		t = 8.3ms
I^2t Maximum I^2t for fusing	770	4525	6380	A ² s	t = 10ms No voltage reappplied
	700	4130	5830		t = 8.3ms
	540	3200	4510		t = 10ms 100% V_{RRM} reappplied
	500	2920	4120		t = 8.3ms
$I^2\sqrt{t}$ Maximum $I^2\sqrt{t}$ for fusing	7700	45250	63800	A ² √s	t = 0.1 to 10ms, no voltage reappplied
$V_{T(TO)1}$ Low level value of threshold voltage	1.17	1.09	1.04	V	(16.7% $\times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}$), @ T_J max.
$V_{T(TO)2}$ High level value of threshold voltage	1.45	1.27	1.27		($I > \pi \times I_{T(AV)}$), @ T_J max.
$r_{\theta 1}$ Low level value on-state slope resistance	12.40	4.10	3.93	mΩ	(16.7% $\times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}$), @ T_J max.
$r_{\theta 2}$ High level value on-state slope resistance	11.04	3.59	3.37		($I > \pi \times I_{T(AV)}$), @ T_J max.
V_{TM} Maximum on-state voltage drop	2.68	1.65	1.57	V	$I_{pk} = 150\text{A}$, $T_J = 25^\circ\text{C}$ $t_p = 400\mu\text{s}$ single junction
di/dt Max. non-repetitive rate of rise of turned on current	150			A/μs	$T_J = 25^\circ\text{C}$, from 0.67 V_{DRM} , $I_{TM} = \pi \times I_{T(AV)}$, $I_g = 500\text{mA}$, $t_r < 0.5\mu\text{s}$, $t_p > 6\mu\text{s}$
I_H Max. holding current	200			mA	$T_J = 25^\circ\text{C}$, anode supply = 6V, resistive load, gate open circuit
I_L Max. latching current	400				$T_J = 25^\circ\text{C}$, anode supply = 6V, resistive load

Blocking

Parameter	53MT.KB 52MT.KB 51MT.KB	93MT.KB 92MT.KB 91MT.KB	113MT.KB 112MT.KB 111MT.KB	Units	Conditions
V _{INS} RMS isolation voltage	4000			V	T _J = 25°C all terminal shorted f = 50Hz, t = 1s
dv/dt Max. critical rate of rise of off-state voltage (*)	500			V/μs	T _J = T _J max., linear to 0.67 V _{DRM} , gate open circuit

(*) Available with dv/dt = 1000V/ms, to complete code add S90 i.e. 113MT160KBS90.

Triggering

Parameter	53MT.KB 52MT.KB 51MT.KB	93MT.KB 92MT.KB 91MT.KB	113MT.KB 112MT.KB 111MT.KB	Units	Conditions	
P _{GM} Max. peak gate power	10			W	T _J = T _J max.	
P _{G(AV)} Max. average gate power	2.5					
I _{GM} Max. peak gate current	2.5			A		
-V _{GT} Max. peak negative gate voltage	10			V		
V _{GT} Max. required DC gate voltage to trigger	4.0			V	T _J = -40°C	
	2.5				T _J = 25°C	Anode supply = 6V, resistive load
	1.7				T _J = 125°C	
I _{GT} Max. required DC gate current to trigger	270			mA	T _J = -40°C	
	150				T _J = 25°C	Anode supply = 6V, resistive load
	80				T _J = 125°C	
V _{GD} Max. gate voltage that will not trigger	0.25			V	@ T _J = T _J max., rated V _{DRM} applied	
I _{GD} Max. gate current that will not trigger	6			mA		

Thermal and Mechanical Specifications

Parameter	53MT.KB 52MT.KB 51MT.KB	93MT.KB 92MT.KB 91MT.KB	113MT.KB 112MT.KB 111MT.KB	Units	Conditions
T _J Max. junction operating temperature range	-40 to 125			°C	
T _{stg} Max. storage temperature range	-40 to 125			°C	
R _{thJC} Max. thermal resistance, junction to case	0.18	0.14	0.12	K/W	DC operation per module
	1.07	0.86	0.70		DC operation per junction
	0.19	0.15	0.12		120° Rect conduction angle per module
	1.17	0.91	0.74		120° Rect conduction angle per junction
R _{thCS} Max. thermal resistance, case to heatsink	0.03			K/W	Per module Mounting surface smooth, flat and greased
T Mounting torque ± 10%	to heatsink	4 to 6		Nm	A mounting compound is recommended and the torque should be rechecked after a period of 3 hours to allow for the spread of the compound. Lubricated threads.
	to terminal	3 to 4			
wt Approximate weight	225			g	

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ΔR Conduction (per Junction)

(The following table shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC)

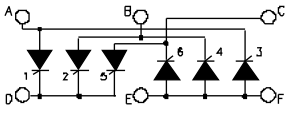
Devices	Sinusoidal conduction @ T_J max.					Rectangular conduction @ T_J max.					Units
	180°	120°	90°	60°	30°	180°	120°	90°	60°	30°	
53/52/51MT.KB	0.072	0.085	0.108	0.152	0.233	0.055	0.091	0.117	0.157	0.236	K/W
93/92/91MT.KB	0.033	0.039	0.051	0.069	0.099	0.027	0.044	0.055	0.071	0.100	
113/112/111MT.KB	0.027	0.033	0.042	0.057	0.081	0.023	0.037	0.046	0.059	0.082	

Ordering Information Table

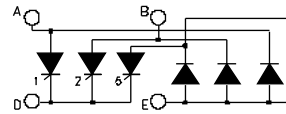
Device Code

11	3	MT	160	K	B	S90
①	②	③	④	⑤	⑥	

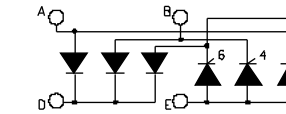
- 1** - Current rating code: 5 = 55 A (Avg)
9 = 90 A (Avg)
11 = 110 A (Avg)
- 2** - Circuit configuration code: 3 = Full-controlled bridge
2 = Positive half-controlled bridge
1 = Negative half-controlled bridge
- 3** - Essential part number
- 4** - Voltage code: Code x 10 = V_{RRM} (See Voltage Ratings Table)
- 5** - Generation II
- 6** - Critical dv/dt: None = 500V/μs (Standard value)
S90 = 1000V/μs (Special selection)



full-controlled bridge
(53, 93, 113MT..KB)



positive half-controlled bridge
(52, 92, 112MT..KB)



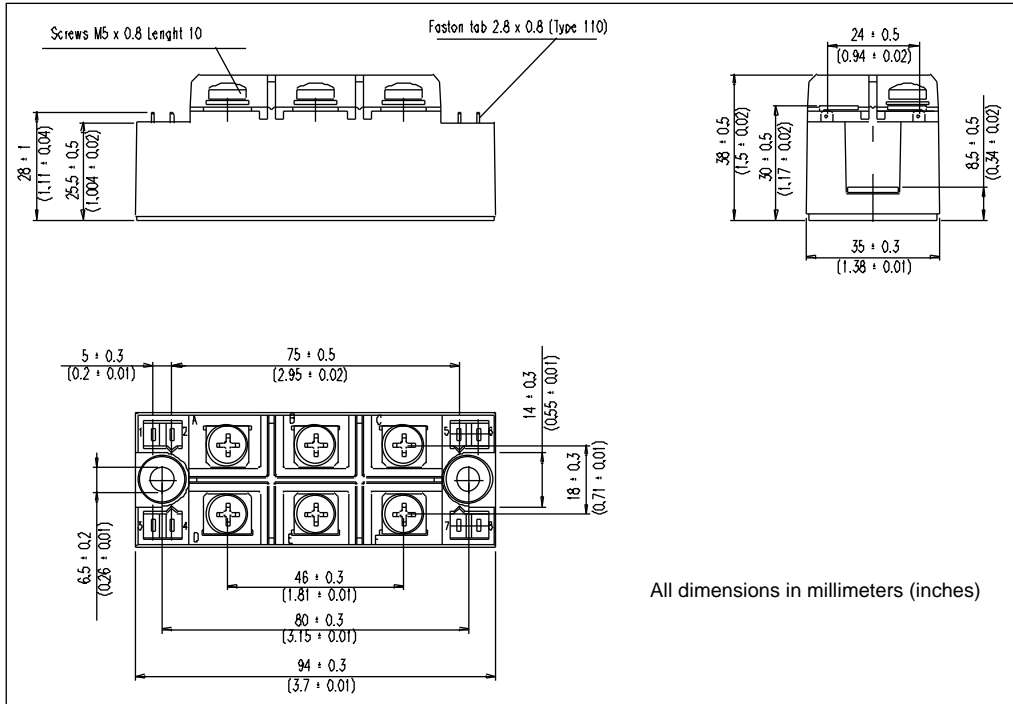
negative half-controlled bridge
(51, 91, 111MT..KB)

NOTE: To order the Optional Hardware see Bulletin I27900

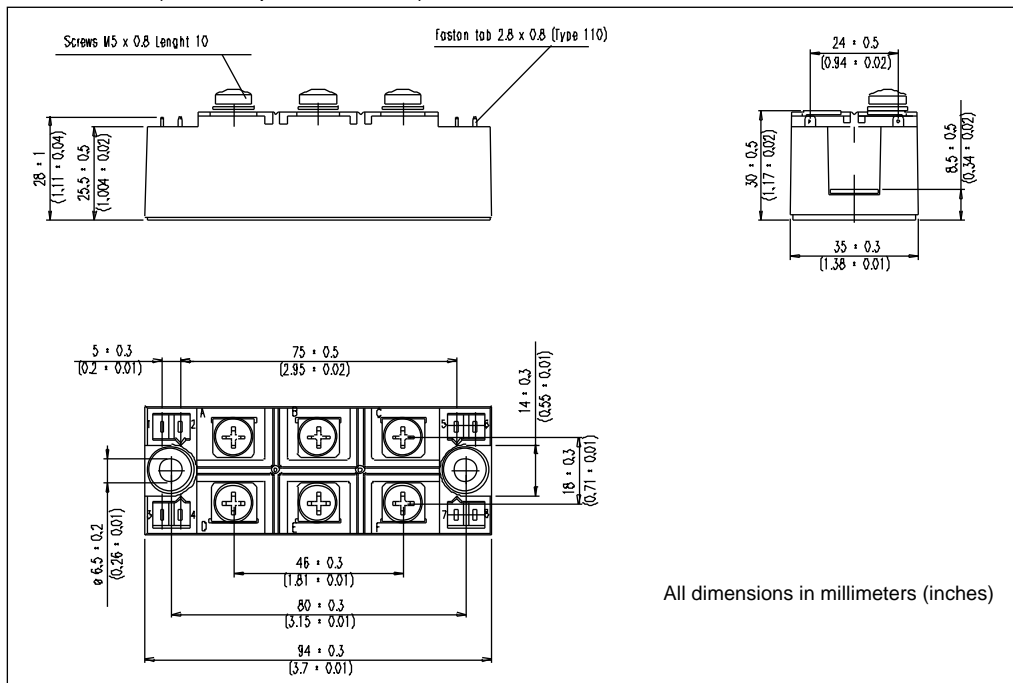
Document Number: 93557

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Outline Table (with optional barriers)



Outline Table (without optional barriers)



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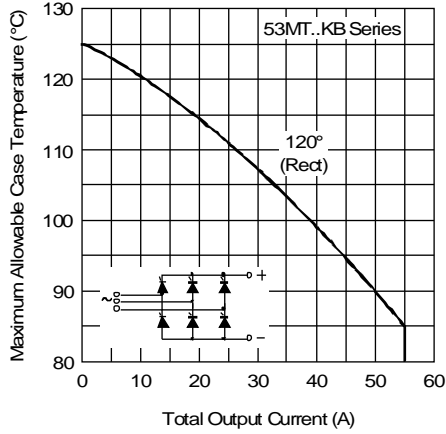


Fig. 1 - Current Ratings Characteristic

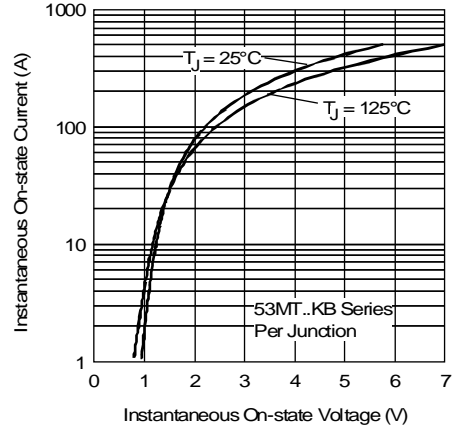


Fig. 2 - Forward Voltage Drop Characteristics

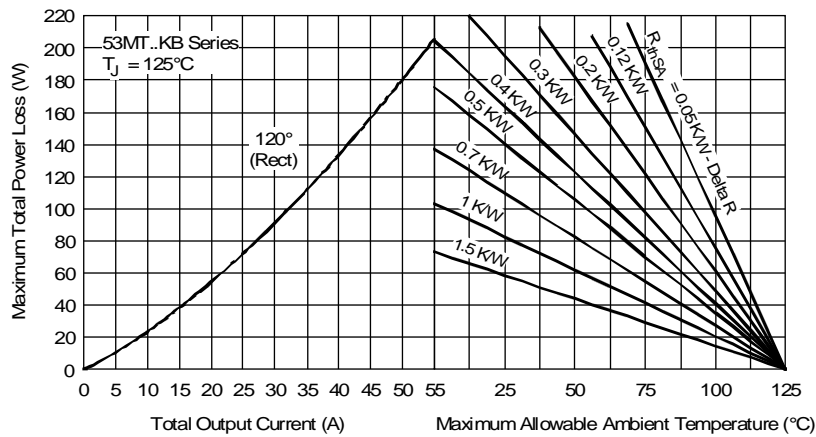


Fig. 3 - Total Power Loss Characteristics

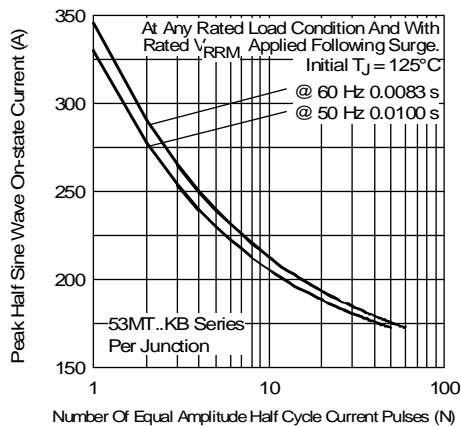


Fig. 4 - Maximum Non-Repetitive Surge Current

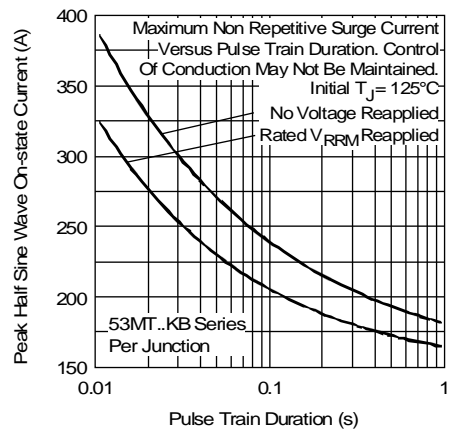


Fig. 5 - Maximum Non-Repetitive Surge Current

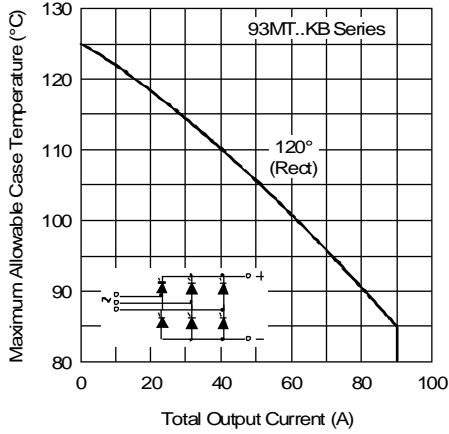


Fig. 6 - Current Ratings Characteristic

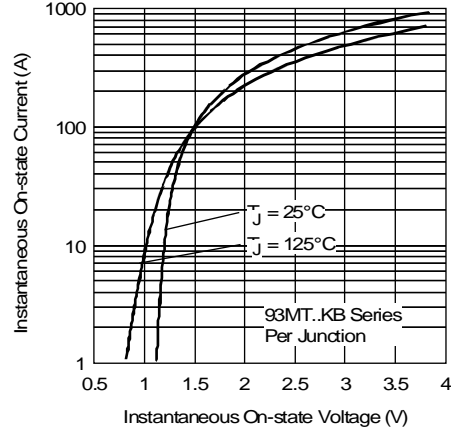


Fig. 7 - Forward Voltage Drop Characteristics

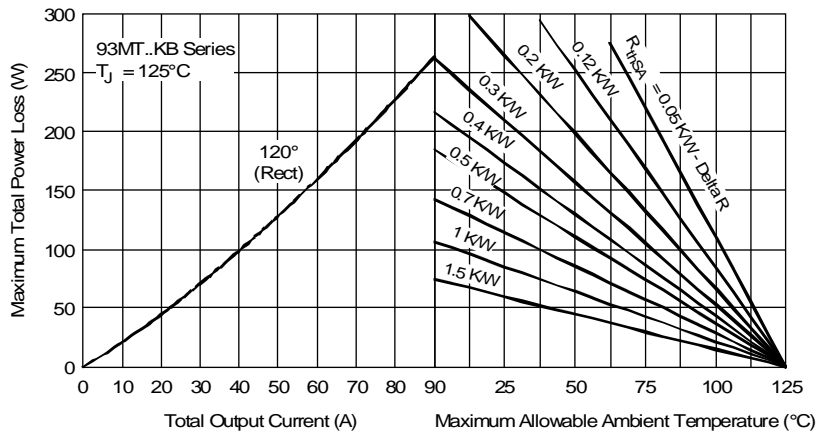


Fig. 8 - Total Power Loss Characteristics

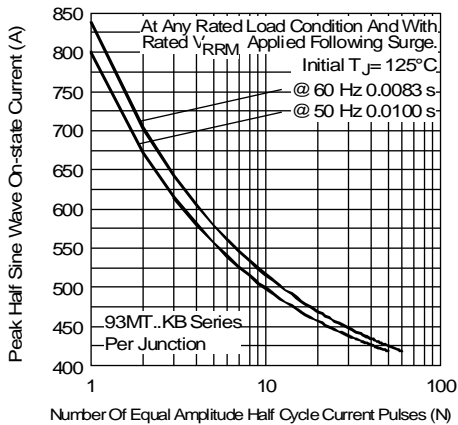


Fig. 9 - Maximum Non-Repetitive Surge Current

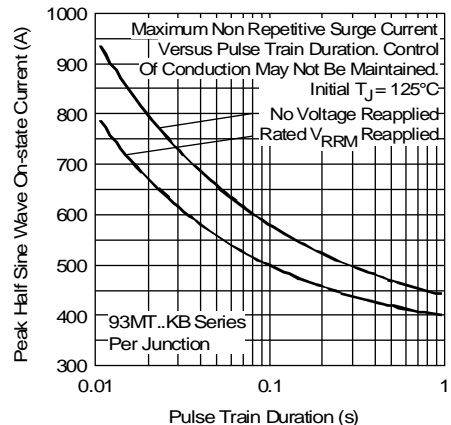


Fig. 10 - Maximum Non-Repetitive Surge Current

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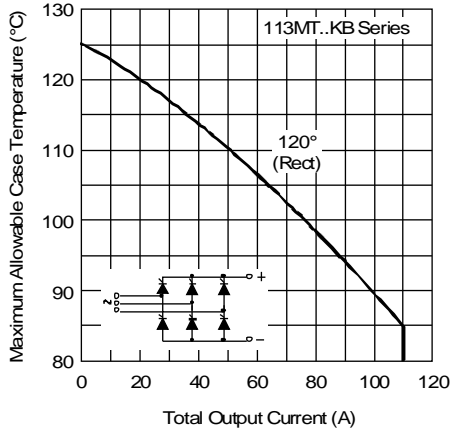


Fig. 11 - Current Ratings Characteristic

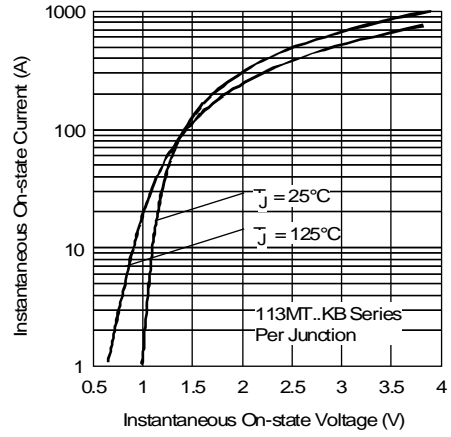


Fig. 12 - Forward Voltage Drop Characteristics

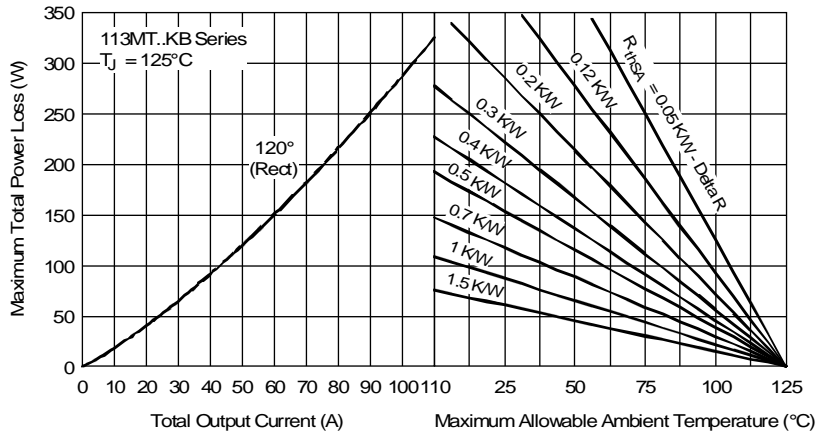


Fig. 13 - Total Power Loss Characteristics

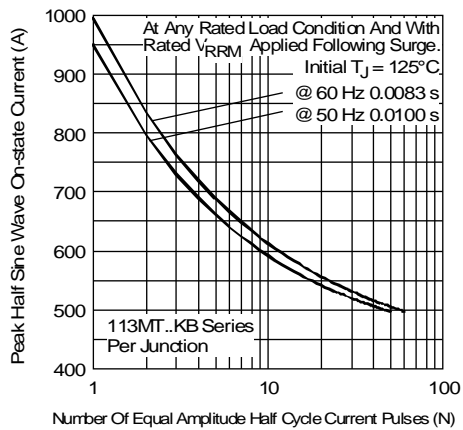


Fig. 14 - Maximum Non-Repetitive Surge Current

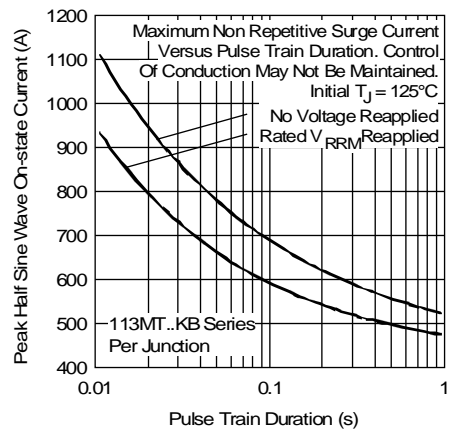


Fig. 15 - Maximum Non-Repetitive Surge Current

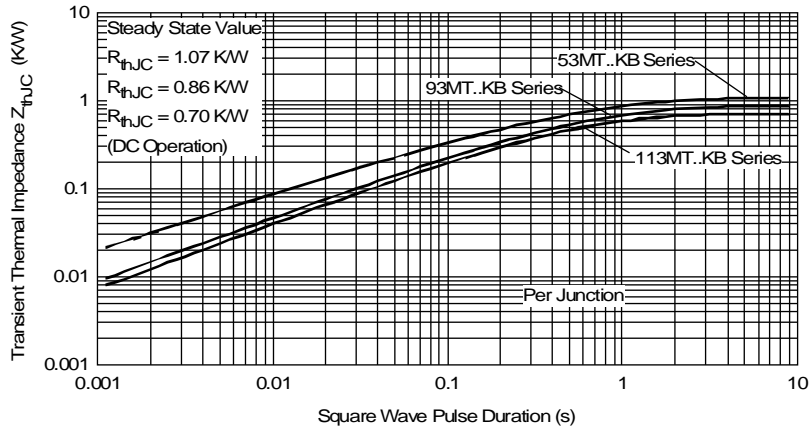


Fig. 16 - Thermal Impedance Z_{thJC} Characteristics

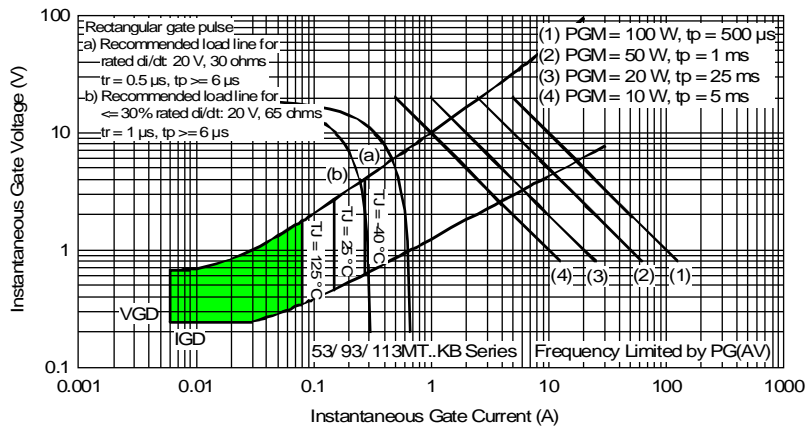


Fig. 17 - Gate Characteristics



Notice

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